

**AMENDMENTS TO THE SPECIFICATION:**

Please Amend the Specification as follows:

[0008] Japanese Laid-Open Patent Application No. ~~2002-35072~~2002-350726 discloses to form the second unit by a positive lens and a cemented lens which is obtained by joining three lens elements of a positive lens, a negative lens and a positive lens, for the purpose of lowering the eccentric sensitivity of the second unit. However, this zoom lens system is not compact because the second unit is thick along an optical axis direction.

[0013] Preferred embodiments of the present invention will now be described with reference to associated drawings. An imaging lens device which is one preferred embodiment of the present invention, as shown in Fig. [[21]] 1 for instance, comprises a zoom lens system TL which generates an optical image of an object which can be zoomed in and out, an optical low pass filter LPF, and an imaging sensor SR which converts an optical image generated by the zoom lens system TL into an electric signal, all of which are disposed in this order from the object side. Further, the zoom lens system comprises a first lens unit Gr1 including a prism PR (Fig. 5) which internally comprises a reflection surface, and subsequent lens units. The imaging lens device is a principal element of a camera which is disposed within or externally attached to a digital camera, a video camera, a personal computer, a mobile computer, a cellular telephone, a PDA (personal digital assistance), etc.

[0016] The imaging sensor SR (Fig. 21) comprises a CCD having a plurality of pixels and converts an optical image generated by the zoom lens system into an electric signal using the CCD. The signal generated by the imaging sensor SR is recorded in a memory (e.g., a semiconductor memory, an optical disk) as a digital

Application No. 10/656,007  
Amendment dated March 16, 2005  
Reply to Notice of Allowance dated December 20, 2004

image signal after subjected to predetermined digital image processing, image compression processing and the like in accordance with a necessity, and is further transferred to other equipment via a cable or as it is converted into an infrared signal in some cases. The CCD may be replaced with a CMOS (Complementary Metal-oxide Semiconductor ) sensor.